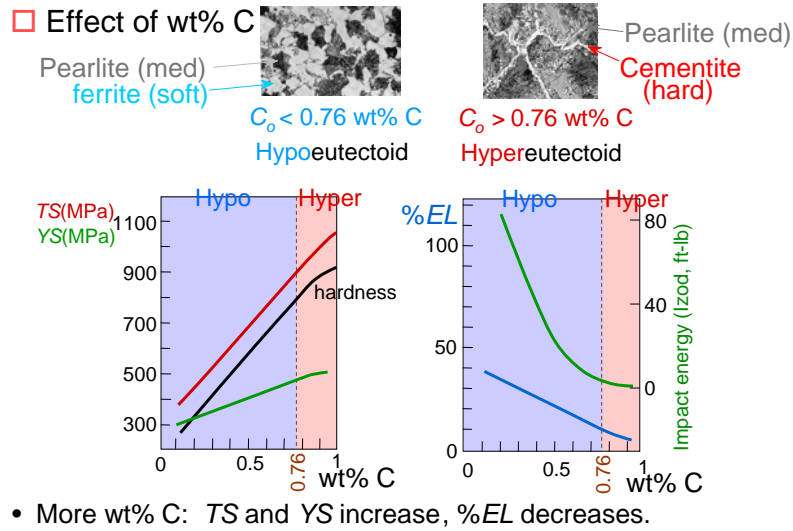
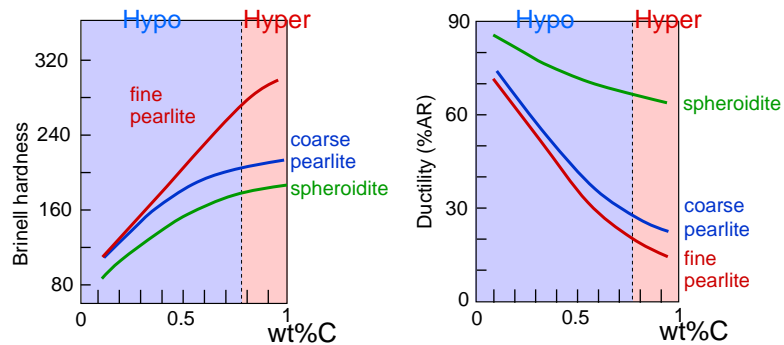


Mechanical prop: Fe-C System (1)



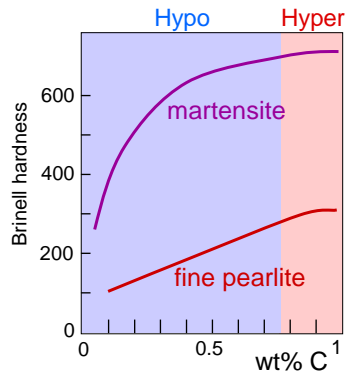
Mechanical prop: Fe-C system (2)

□ Fine vs coarse pearlite vs spheroidite



Mechanical Prop: Fe-C system (3)

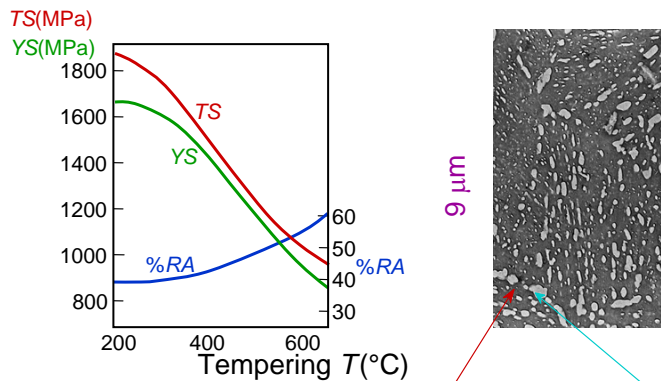
□ Fine Pearlite vs Martensite:



- Hardness: fine pearlite << martensite.

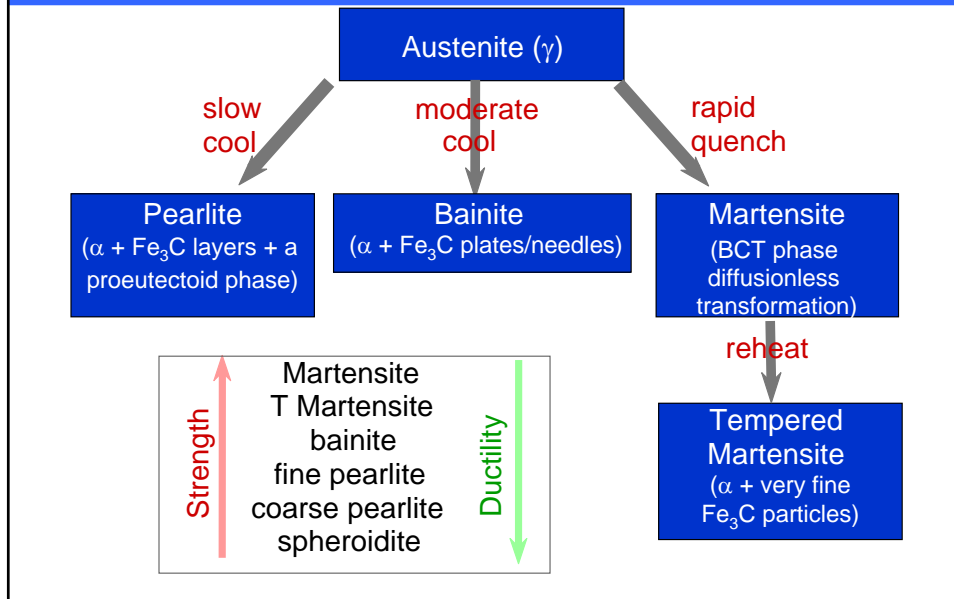
Tempering martensite

- reduces brittleness of martensite,
- reduces internal stress caused by quenching

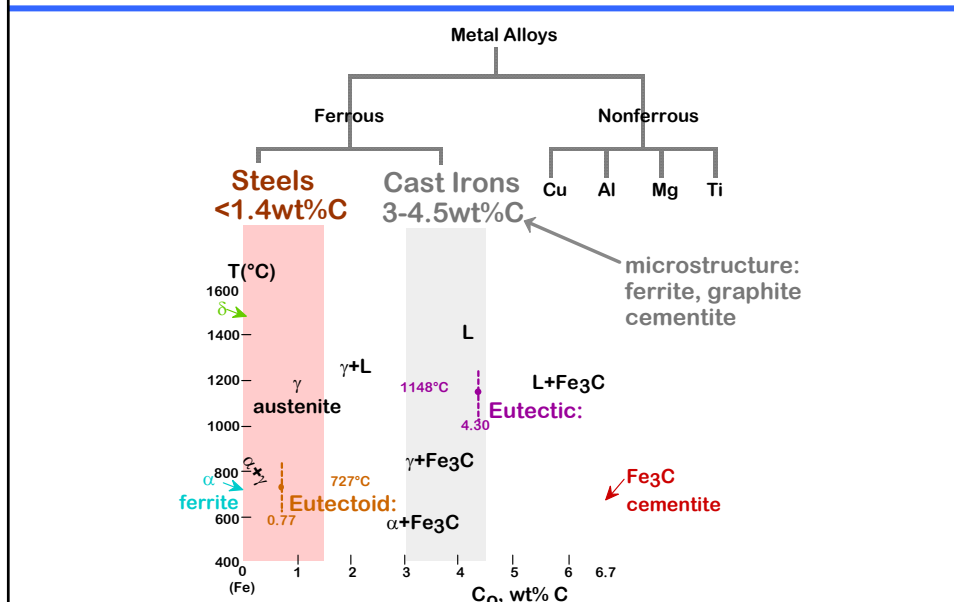


- produces extremely small Fe_3C particles surrounded by α .
- decreases TS , YS but increases $\%RA$

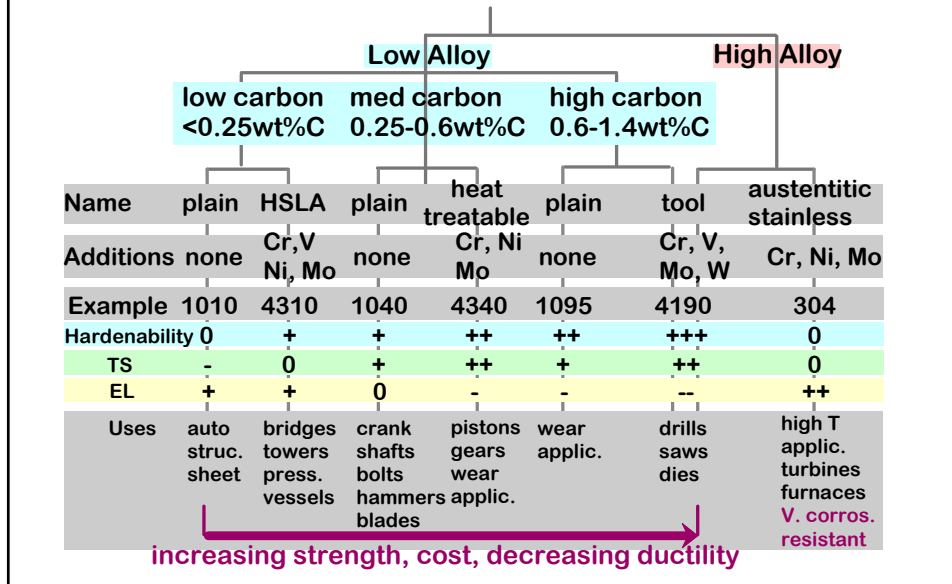
Summary: Processing options



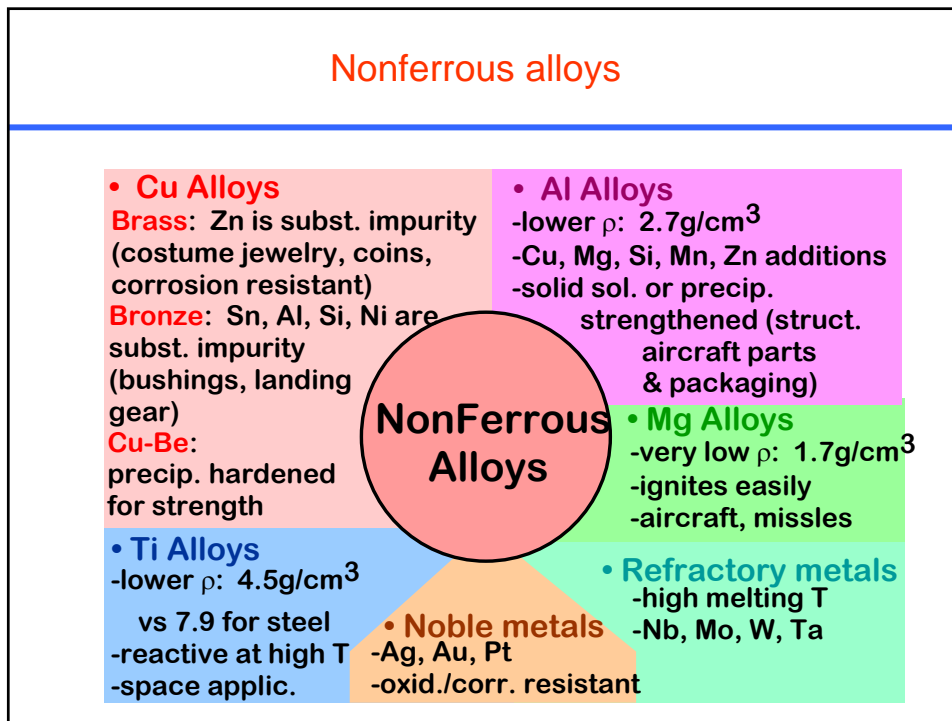
Chap11.Applications and processing of metal alloys



Steels



Nonferrous alloys



Chapter 12 Structures and properties of ceramics

- Bonding in ceramics
- Imperfection in ceramics
- Electric properties of ceramics
- Ceramic phase diagrams
- Brittle fracture of ceramics
- Stress-strain behavior
- Mechanisms of plastic deformation

Ceramic bonding

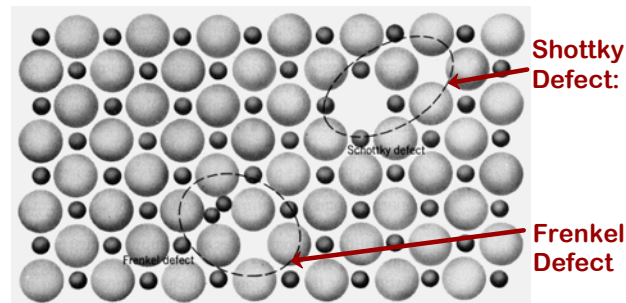
- **Bonding:**
 - Mostly ionic, some covalent.
 - % ionic character increases with difference in electronegativity.

| | | | | | | | | | | | | | | | | | | | | | | |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|------|-------|------|-----|------|-------|-----|----|
| | | | | | | | | | | | | | | | | 0 | | | | | | |
| I A | | | | | | | | | | | | | | | II A | III A | IV A | V A | VI A | VII A | 0 | |
| H | Li | Be | | | | | | | | | | | | | | | B | C | N | O | F | Ne |
| 2.1 | 1.0 | 1.5 | | | | | | | | | | | | | | | 2.0 | 2.5 | 3.0 | 3.5 | 4.0 | - |
| Na | Mg | | | | | | | | | | | | | | | Al | Si | P | S | Cl | Ar | |
| 0.9 | 1.2 | | | | | | | | | | | | | | | 1.5 | 1.8 | 2.1 | 2.5 | 3.0 | - | |
| K | Ca | Ti | Cr | Fe | Ni | Zn | As | Br | Kr | | | | | | | | | | | | | |
| 0.8 | 1.0 | 1.5 | 1.6 | 1.8 | 1.8 | 1.8 | 2.0 | 2.8 | - | | | | | | | | | | | | | |
| Rb | Sr | Zr | Nb | Mo | Tc | Ru | Rh | Pd | Ag | Cd | In | Sn | Sb | Te | I | Xe | | | | | | |
| 0.8 | 1.0 | 1.2 | 1.4 | 1.6 | 1.8 | 2.2 | 2.2 | 2.2 | 1.9 | 1.7 | 1.7 | 1.8 | 1.9 | 2.1 | 2.5 | - | | | | | | |
| Cs | Ba | Hf | Ta | W | Re | Os | Ir | Pt | Au | Hg | Tl | Pb | Bi | Po | At | Rn | | | | | | |
| 0.7 | 0.9 | 1.3 | 1.5 | 1.7 | 1.9 | 2.2 | 2.2 | 2.2 | 2.4 | 1.9 | 1.8 | 1.8 | 1.9 | 2.0 | 2.2 | - | | | | | | |
| Fr | Ra | | | | | | | | | | | | | | | | | | | | | |
| 0.7 | 0.9 | | | | | | | | | | | | | | | | | | | | | |

Table of Electronegativities

Imperfections in ceramics

- Schottky defects: --a paired set of cation and anion vacancies.
- Frenkel defects: an atom from a lattice site to an interstitial position

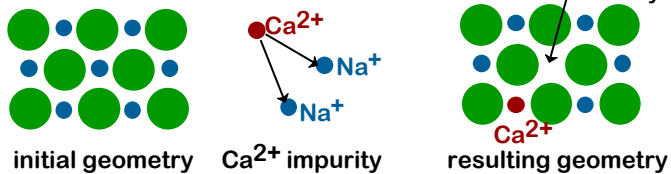


Point defects in ionic crystals

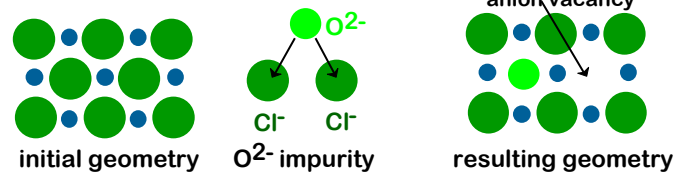
- Impurities must also satisfy charge balance

• Ex: NaCl Na^+ Cl^-

• Substitutional cation impurity



• Substitutional anion impurity



Point defects in ionic crystals

□ Defect examples for other ionic crystal systems

☑ In simple ionic crystals, both Schottky and Frenkel defects occur, but the concentration of one type generally exceeds that of the other

- Schottky defects dominate in alkali halides
- Cation Frenkel defects dominate in AgCl and AgBr
- Anion Frenkel defects dominate in CaF₂ and fluorites

Electric properties

□ Electrical conductivity: the mobility of charged point defects

$$\sigma = n(\mu^+ + \mu^-)e$$

$$\approx n\mu^+e \approx \exp\left(-\frac{Ea}{KT}\right)$$

Since the cation vacancy is more mobile than anion vacancy

n -- defect concentration

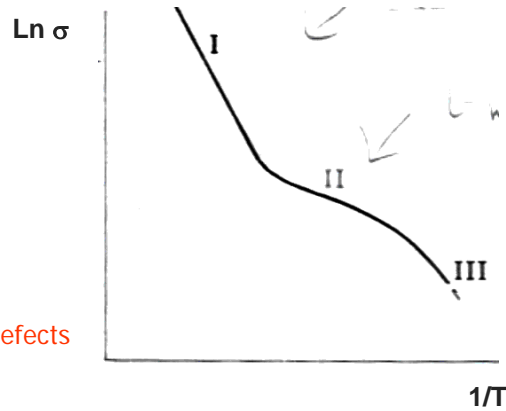
e -- charge

μ -- mobility

Electric properties (continue)

□ Electrical conductivity

- Region I: Schottky defects
 $E_a = E_m^+ + 1/2(E_{+} + E_{-})$
- Region II: Cation vacancies
 $E_a = E_m^+$
- Region III: cation vacancies, impurity ions, clustering of defects

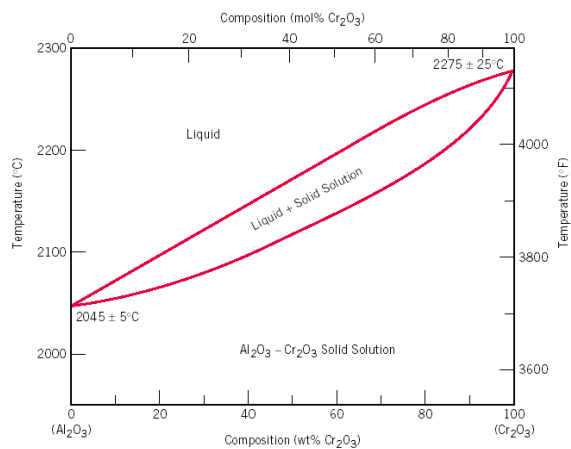


Effect of temperature on electrical conductivity of a NaCl crystal containing a small conc. of a divalent cation

Ceramic phase diagram

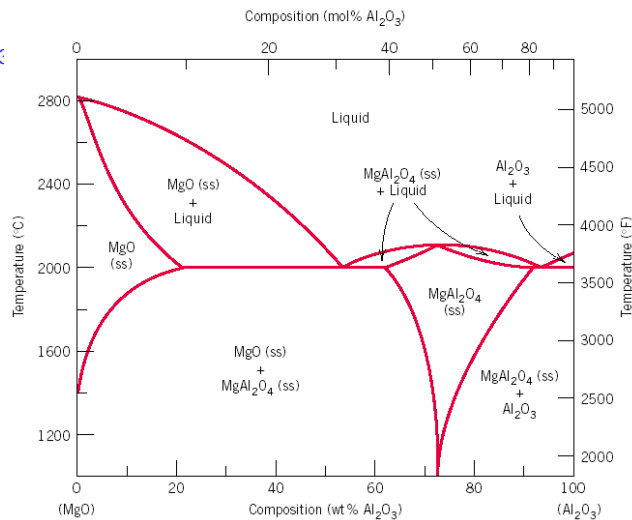
□ The Al_2O_3 - Cr_2O_3 system

- Isomorphous
- In solid solution Al^{3+} substitute Cr^{3+}
- Al and Cr should have similar radius and same charge
- Both Al_2O_3 and Cr_2O_3 have the same crystal structure



Ceramic phase diagram

- The $\text{Mg}_2\text{O}-\text{Al}_2\text{O}_3$ system
- Intermediate phase -- spinel compound

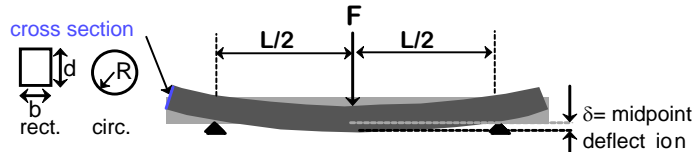


Stress-strain behavior

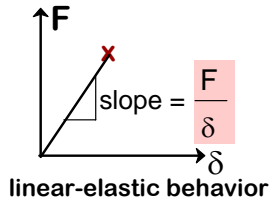
- Flectural testing replace tensile testing
- Reasons for not a standard tension test
 - difficult to prepare and test specimens having a required geometry
 - difficult to grip brittle materials without fracturing them
 - ceramics fail after only about 0.1% strain and samples are difficult to align without experiencing bending stress

Measuring elastic modulus

- Room T behavior is usually elastic, with brittle failure. 3-Point Bend Testing often used.
- Tensile tests are difficult for brittle materials.



- Determine elastic modulus according to:

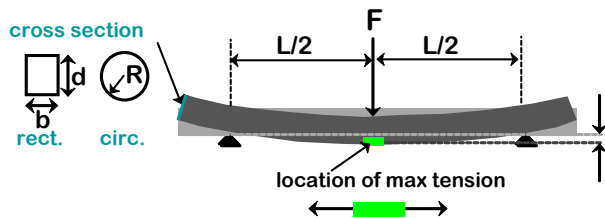


$$E = \frac{F}{\delta} \frac{L^3}{4bd^3} = \frac{F}{\delta} \frac{L^3}{12\pi R^4}$$

rect. cross section circ. cross section

Measuring strength

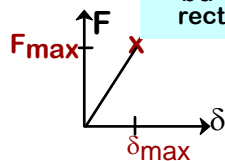
- 3-point bend test to measure room T strength.



- Flexural strength:

$$\sigma_{fs} = \sigma_m^{fail} = \frac{1.5F_{max}L}{bd^2} = \frac{F_{max}L}{\pi R^3}$$

rect. circ.



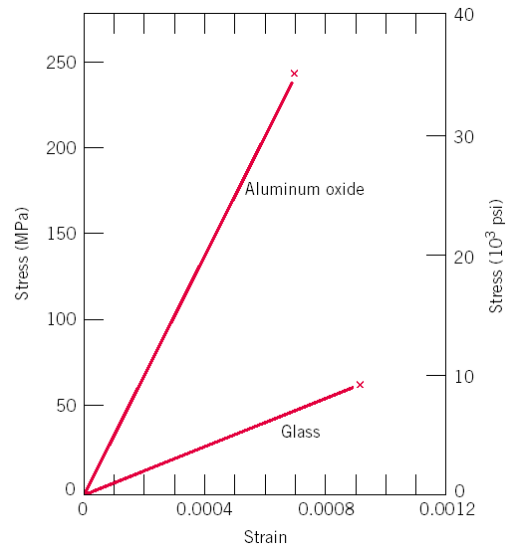
- Typ. values:

| Material | σ_{fs} (MPa) | E (GPa) |
|--------------|---------------------|---------|
| Si nitride | 700-1000 | 300 |
| Si carbide | 550-860 | 430 |
| Al oxide | 275-550 | 390 |
| glass (soda) | 69 | 69 |

Data from Table 12.3, Callister 6e.

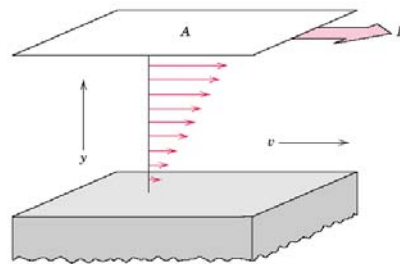
Elastic behavior

- Typical stress-strain behavior to fracture for aluminum oxide and glass



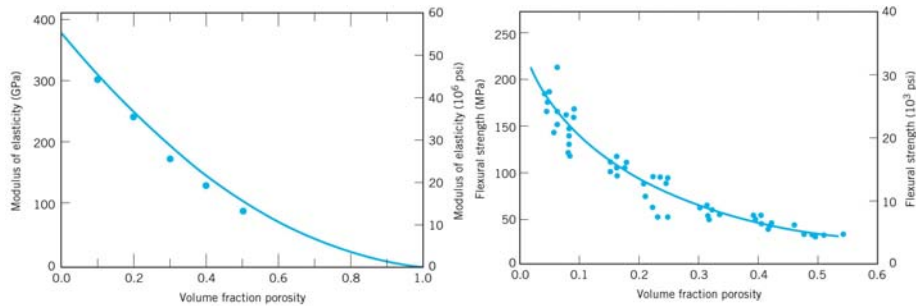
Mechanisms of plastic deformation

- Crystalline ceramics are brittle
 - Covalent bonds are relatively strong
 - There are limited numbers of slip systems
 - Dislocation structures are complex
- Noncrystalline ceramics
 - Plastic deformation does not occur by dislocation motion for noncrystalline ceramics
 - Viscosity is a measure of non-crystalline material's resistance to deformation



Influence of porosity on mechanical behavior

- $E = E_0(1 - 1.9P + 0.9P^2)$
- $\sigma_{fs} = \sigma_0 \exp(-nP)$



Hardness

Table 13.6 Approximate Knoop Hardness (100 g load) for Seven Ceramic Materials

| <i>Material</i> | <i>Approximate Knoop Hardness</i> |
|--|-----------------------------------|
| Diamond (carbon) | 7000 |
| Boron carbide (B ₄ C) | 2800 |
| Silicon carbide (SiC) | 2500 |
| Tungsten carbide (WC) | 2100 |
| Aluminum oxide (Al ₂ O ₃) | 2100 |
| Quartz (SiO ₂) | 800 |
| Glass | 550 |

Summary

- Ceramic materials have mostly ionic bonding & some covalent bonding.
- Defects
 - must preserve charge neutrality
 - have a concentration that varies exponentially w/T.
- Room T mechanical response is elastic, but fracture is brittle, with negligible ductility.
- Elevated T creep properties are generally superior to those of metals (and polymers).